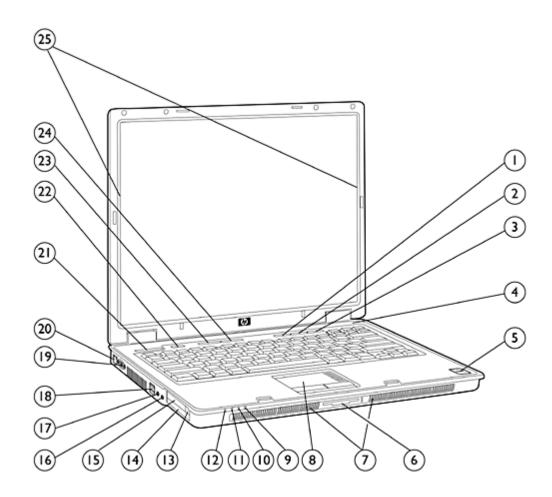
Overview

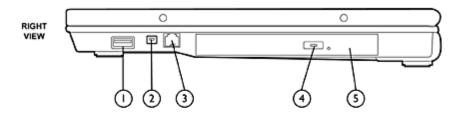


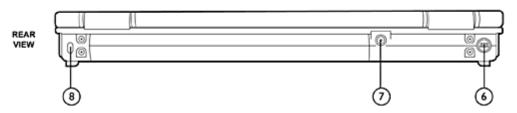
- 1. Volume Mute Button with LED
- 2. Volume Down Button
- 3. Volume Up Button
- 4. Integrated Microphone
- 5. HP Biometric Fingerprint Sensor
- 6. 7-in-1 Media Reader
- 7. Stereo Speakers
- 8. Touchpad with Scroll Zone
- Hard Drive Activity LED
- 10. Battery Charging LED
- 11. Power/Standby LED
- 12. Wireless On/Off LED
- 13. PC Card Eject Button

- 14. ExpressCard Slot
- 15. PC Card Slot (or optional Smart Card Reader)
- 16. Microphone Jack
- 17. Headphone Jack
- 18. 2 USB 2.0 Ports
- 19. VGA/External Monitor Connector
- 20. RJ-45 Port (NIC)
- 21. Power Button with LED
- 22. HP Info Center Button
- 23. Wireless On/Off Button with LED
- 24. Presentation Mode Button
- 25. Dual-band Wireless LAN Antennas



Overview





- 1. 1 USB 2.0 Port
- 2. IEEE 1394a Port
- 3. RJ-11 Port (Modem)
- 4. Optical Drive Button

- 5. Optical Drive
- 6. S-Video TV Out
- 7. DC Power Connector
- 8. Kensington Lock Slot

At A Glance

- Genuine Windows XP Professional, Genuine Windows XP Home Edition, or FreeDOS
- AMD Turion™ 64 X2 Dual-Core Mobile Technology or Mobile AMD Sempron™ processor
- Sleek industrial design starting at 5.7 lb/2.6 kg and 1.2-inch/30.3 mm thin at front
- ATI RADEON XPRESS 1150 Chipset
- Up to 4GB* of 667-MHz DDR2 SDRAM, dual channel memory support
- Up to 100-GB 5400 rpm, user-removable hard drive
- Optional integrated 802.11 a/b/g or 802.11 b/g wireless LAN module and Bluetooth®
- 7-in-1 Media Reader
- TPM 1.2
- HP Biometric Fingerprint Sensor
- Broadcom NetLink Gigabit Ethernet PCI Controller
- Touchpad with scroll zone
- Protected by one-year or three-year (depending on country) standard parts and labor warranty certain restrictions and exclusions apply
- * Above 3-GB, all memory may not be available due to system resource requirements.



Standard Features

Processors AMD Turion 64 X2 Dual-Core Mobile Processor TL-60 (2.0-GHz, 2 x 512-KB L2 cache)

AMD Turion 64 X2 Dual-Core Mobile Processor TL-56 (1.8-GHz, 2×512 -KB L2 cache) AMD Turion 64 X2 Dual-Core Mobile Processor TL-52 (1.6-GHz, 2×512 -KB L2 cache)

AMD Turion 64 X2 Dual-Core Mobile Processor TL-50 (1.6-GHz, 2 x 256-KB L2 cache)

Mobile AMD Sempron Processor 3500+ (1.8-GHz, 512-KB L2 cache) Mobile AMD Sempron Processor 3400+ (1.8-GHz, 256-KB L2 cache) Mobile AMD Sempron Processor 3200+ (1.6-GHz, 512-KB L2 cache)

NOTE: Processor speed denotes maximum performance mode; processors will run at lower speeds n

battery optimization mode.

Operating System Preinstalled Genuine Windows XP Professional SP2

Genuine Windows XP Home Edition SP2

FreeDOS

Supported Genuine Windows XP Professional x64 Edition

Genuine Windows 2000 (drivers downloadable from http://www.hp.com)

Certified SuSE Linux Enterprise Desktop 10

Novell Linux Desktop 9

Windows Vista Capable Not all Windows Vista features are available for use on all Windows Vista

Capable PCs. All Windows Vista Capable PCs will run the core experiences of Windows Vista, such as innovations in organizing and finding information, security, and reliability. Some features available in premium editions of Windows Vista -- like the new Windows Aero™ user interface -- require

advanced or additional hardware.

Check http://www.windowsvista.com/getready for details.

Chipset ATI Radeon Xpress 1150 Chipset

Graphics ATI Radeon Xpress 1150, up to 128-MB shared system memory

Display Internal 15.0-inch XGA (1024 x 768 resolution and 16 M colors)

15.0-inch XGA BrightView (1024 x 768 resolution and

16 M colors)

15.0-inch SXGA+ wide viewing angle (1400×1050 resolution and 16 M

colors)

External Up to 32-bit per pixel color depth

VGA port supports resolutions up to 2048 x 1536 at 75 Hz, and lower

resolutions at up to 100 Hz

NOTE: Resolutions are dependent upon monitor capability, and resolution

and color depth settings.

Standard Features

Memory

Standard 256-MB, 512-MB, 1024-MB or 2048-MB 667-MHz DDR2 SDRAM; two

SODIMM slots supporting dual channel memory

Maximum Upgradeable to 4096-MB maximum (2048-MB SODIMM in slots 1 and 2)

Dual-channel Maximized dual-channel performance requires SODIMMs of the same size

and speed in both memory slots.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the

lower memory speed. Above 3-GB, all memory may not be available due to system resource

requirements.

Communications

Integrated Broadcom NetLink Gigabit Ethernet PCI Controller (10/100/1000 NIC)*

56K V.92 modem** with digital line guard

* The term "10/100/1000" or "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

** Designed for downloads from 56K modem compliant sources. Maximum achievable download transmission rates currently do not reach 56 KB/s, and will vary with line conditions. Modem availability is subject to country regulatory approval.

Wireless Devices

Support for a broad range of secure, integrated wireless LAN options featuring support for the latest industry standards. Integrated Bluetooth is also an option (factory configurable only) and can be combined with any of the supported wireless LAN options.

All integrated wireless

Wi-Fi certified

LAN options

Cisco Compatible Extensions support (Version 3.0) Wired Equivalent Privacy (WEP) support up to 128-bit keys

Wi-Fi Protected Access (WPA) and WPA2 support

802.1x authentication support, including EAP-TLS, EAP-TTLS, PEAP-GTC,

PEAP-MSCHAPv2, and LEAP

Advanced Encryption Standard (AES) support

WiFi certified for WPA2, WMM

Dual antennas integrated in the display enclosure

Broadcom 4311AG WiFi Integrated support for 802.11a, b and g

Adapter Up to 54-mbps data rate

Adaptor Op to 01 maps data tale

Broadcom 4311BG WiFi Integrated support for 802.11 b and g

Adapter Up to 54-mbps data rate

HP Integrated Module Bluetooth Specification v2.0 compliant with Bluetooth 2.0 Works with a wide range of Bluetooth devices

Wireless Technology

Keyboard

The 101/102-key compatible keyboard features an industry standard, full-pitch key layout with desktop keyboard features, such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, and 12 function keys. US and International key layouts are available. Other features include an integrated numeric keypad, hotkeys for instant access to power conservation, brightness, and other features, 19-mm x 19-mm key pitch (center-to-center spacing), 2.5-mm stroke, comfort-dished keycaps, and bright key legends for improved visibility in low light conditions.



Standard Features

One-Touch Productivity

Buttons

Provide one-touch access to the following features: HP Info Center, Wireless On/Off, Presentation Mode, Volume Up, Volume Down, and Volume Mute

Pointing Device

Touchpad with scroll zone, two soft-touch buttons

Expansion Card Slots

One Type I/II PC Card

Supports 32-bit CardBus and 16-bit PC Cards

slot

or

Optional Integrated Smart Compatible with ISO 7816 compliant Smart Cards

Card Reader

PC/SC interface support

Express Card slot Express Card/34 or ExpressCard/54

Media Slots

7-in-1 Media Reader

Supports SD (Secure Digital), MMC (MultiMedia Card), Memory Stick,

Memory Stick Pro, Memory Stick Duo*, Smart Media, xD-Picture card

*NOTE: Memory Stick Duo Adapters are required and sold separately. Inserting a Memory Stick Duo Card directly into your notebook could damage the memory card and/or notebook.

Storage

Hard Drives

40-, 60-, 80-, 100-GB 5400 rpm SMART SATA

NOTE: These hard drives are customer removable and will withstand multiple insertion/removal cycles.

Up to 8GB is reserved for the system recovery software.

HP Mobile Data Protection System Hard drive is mounted directly to the notebook frame, reducing the

transmission of shock to the hard drive and protecting it during normal use

from shock and vibration.

Fixed Optical Drives

CD-ROM

DVD/CD-RW Combo DVD+/-RW SuperMulti with Double Layer

LightScribe DVD+/-RW SuperMulti with Double Layer

Interfaces

PC Card Slot

One Type I/II or optional Smart Card Reader

Express Card Slot

Express Card/34 or ExpressCard/54

External Monitor

One - VGA

IEEE 1394a Port

One

External Microphone

One

Headphone/Line out

One

Power Connector

One

RJ-11 (Modem)

RJ-45 (NIC)

One

One

S-Video TV Out

One (Support for NTSC/PAL)

USB 2.0

Three

Docking Connector Accessory Battery

One

Connector

One

LED Status Indicators

Twelve



Standard Features

Audio

PremierSound audio/speaker subsystem ADI1981HD High Definition CODEC

Integrated 16-bit Sound Blaster Pro compatible audio

24-bit DAC

Integrated stereo speakers Integrated microphone

External volume up, volume down, and mute buttons

Stereo headphone/line out Stereo microphone in

Software

Preinstalled Software Microsoft Windows XP Adobe Acrobat Reader

HP Backup and Recovery Manager

HP Help and Support Center

HP Mobile Print Driver

HP ProtectTools Security Manager:

BIOS Configuration for HP ProtectTools Embedded Security for HP ProtectTools Credential Manager for HP ProtectTools

HP Quick Launch Buttons HP Wireless Assistant Sonic Digital Media Plus:

RecordNow! (for optional DVD+/-RW and DVD/CDRW drives) MyDVD (DVD Authoring for optional DVD+/-RW drives)

Synaptics Touchpad Driver

Symantec Norton Internet Security with complimentary 60-day live update Intervideo WinDVD – DVD Player (for optional DVD+/-RW, DVD/CDRW

and DVD drives)

Additional software available from the Web

Smart Card Security for HP ProtectTools
Device Access Manager for HP ProtectTools

HP Backup and Recovery Manager Each unit is shipped with HP Backup and Recovery Manager. HP Backup and Recovery Manager can provide data and system file protection for HP business PCs to enable fast recovery if the system becomes corrupted or if important information is accidentally deleted. HP Backup and Recovery Manager can perform scheduled or manual backups of the entire drive or individual files and folders. Up to 8GB of the hard drive is reserved for the system recovery software. HP Backup and Recovery Manager can also create software recovery CDs or DVDs (requires optional hardware).

SMBIOS Version 2.4

System Management BIOS, previously known as DMI BIOS, is used to store system management information.

Standard Features

HP ProtectTools Security Manager

HP ProtectTools Security Manager is the security platform for business notebooks and desktops. The HP ProtectTools Security Manager is an extensible client security console that delivers enhanced security capabilities through add-on software modules. Modules currently available are:

- Smart Card Security for HP ProtectTools
- BIOS Configuration for HP ProtectTools
- Credential Manager for HP ProtectTools
- Device Access Manager for HP ProtectTools

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Standard Features HP ProtectTools Security Manager

HP Biometric Fingerprint Sensor Configuration Control Hardware

Memory Change Alert Ownership Tag Setup Password Power-On Password

DriveLock

TPM Enhanced DriveLock

HP Disk Sanitizer

Enabled for PC Smart Card options TPM 1.2 Embedded Security Chip

Kensington Lock Slot

Support for Computrace / LoJack for Laptops (must be purchased

Cards

separately)

Optional Features Smart Card Reader

Compatible with ISO 7816 compliant Smart

(replaces Type I/II PC

Card slot) PC/SC interface support

For more information on HP security solutions refer to http://www.hp.com/go/security.

Power Supply

External 65-watt Smart AC adapter, 6-foot (1.8-meter) power cord included.

Total length including External AC adapter is 12 feet (3.66 meter).

HP Fast Charge Technology*

*Fast Charge Technology recharges your battery up to 90% within 90 minutes when the system is off. Fast Charge Technology does not apply to 12-cell Ultra-Capacity batteries.

Battery

Primary Battery 55Wh 6-cell high capacity Lithium-Ion

43Wh 6-cell high capacity Lithium-Ion

Optional HP 8-Cell Extended Life Battery 52Wh 8-cell high capacity Lithium-Ion

Optional HP 12-Cell Ultra-Capacity Battery

95Wh 12-cell high capacity Lithium-Ion



Standard Features

Battery Life Primary Battery 55Wh: Up to 4 hours

Primary Battery and 55Wh: Up to 8 hours and 15 minutes optional HP 8-Cell

Extended Life Battery

Primary Battery and 55Wh: Up to 11 hours and 15 minutes

optional HP 12-Cell Ultra-Capacity Battery

NOTE: Battery life will vary depending on the product configuration, product model, applications loaded on the product, power management settings of the product, and the product features used by the customer. As with all batteries, the maximum capacity of this battery will decrease with time and usage.

System Standby Time Up to 1 week

Power Conservation ATI PowerPlay technology

Hibernation Standby

ACPI compliance

Docking HP Docking Station

HP Advanced Docking Station HP Adjustable Notebook Stand

HP's shared docking solutions provide simple and convenient port replication and cable management. Features include Gigabit NIC pass through, modem pass through, legacy parallel and serial ports, S-video TV out, USB 2.0 ports, integrated security mechanism*, integrated MultiBay II and ExpressCard** slots. These docking solutions are compatible across multiple Business Notebook platforms enabling a lower total cost of ownership.

- * HP/Kensington Cable Lock required (purchased separately)
- * HP Advanced Docking Station only

Service and Support

HP Services includes a one-year standard parts and labor warranty, pick-up or carry-in, and toll-free 7 x 24 hardware technical phone support. On-site service and warranty upgrades are also available.

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp.



Options

Memory	HP 256-MB (DDR2 533 MHz) SODIMM	PE830A
	HP 512-MB (DDR2 533 MHz) SODIMM	PE831A
	HP 1-GB (DDR2 533 MHz) SODIMM	PE832A
	HP 512-MB (DDR2 667 MHz) SODIMM	EM993AA
	HP 1-GB (DDR2 667 MHz) SODIMM	EM994AA
	HP 2-GB (DDR2 667 MHz) SODIMM	EM995AA
MultiBay II Storage	HP MultiBay II DVD-ROM Drive	PA849A
(9.5-mm)	HP MultiBay II DVD/CD-RW Combo Drive	PA850A
NOTE: Requires HP Advanced Docking Station	HP MultiBay II DVD+/-RW Drive	PA851A
or HP External MultiBay II	HP 80-GB 5400rpm MultiBay II Hard Drive	PH357A
Other Storage	HP 80-GB 5400rpm SATA Hard Drive	ET354AA
J	HP 12.7mm DVD+/-RW LightScribe Drive	ET353AA
	HP USB Digital Drive + 128-MB SD Memory	DL702AA
	HP USB Diskette Drive	DC361B
Expansion Solutions	HP Docking Station with Smart Adapter	EN488AA#xxx
	HP Advanced Docking Station with Smart Adapter	EN489AA#xxx
	HP 3-in1 NAS Docking Station	EM537AA#xxx
	HP Standard Monitor Stand	PA507A
	HP Adjustable Notebook Stand	PA508A
	HP 9.5mm External MultiBay II Cradle	PA509A#xxx
	HP 4-port USB 2.0 Hub	DG954A
Power	HP (WW) 2-Bay Battery Charging Station	DT533A#xxx
	HP (NA) 10-Bay Battery Charging Station	DT534A#ABA
	HP (4200/6100/6200/8200) Battery Adapter Kit	PK402A
	HP 65W Smart AC Adapter	ED494AA#xxx
	HP 90W Smart AC Adapter	ED495AA#xxx
	HP 90W Smart Auto Adapter	ED493AA
	HP 65W Air/Auto/AC Combo Adapter	ED993AA#xxx
	HP (6100/6200 series) 6-Cell Li-Ion Primary Battery	PB994A
	HP 8-cell Extended Life Battery	PB993A
	HP 12-cell Ultra-Capacity Battery	EJ092AA



Options		
Carrying Cases	HP Value Carrying Case	DL617A
	HP Top Load Nylon Carrying Case	DC915A
	HP Executive Nylon/Leather Case	PA847A
	HP Sport Backpack	DG102A
Security	HP Smart Card Reader with Java Card	EL347AA
	Java Card Bulk Pack (1-100)	EL348AA
	HP/Kensington MicroSaver Security Lock	PC766A
Input/Output Devices	HP USB/PS2 Keyboard	DC852A#xxx
	HP USB/PS2 Optical 2-Button Scroll Mouse	DC369A
	HP USB Optical Travel Mouse	F2100A

Memory

Support for up to 4096 MB* of 667-MHz DDR2 SDRAM

Two DIMM slots

DIMM sizes supported: 256 MB, 512 MB, 1024 MB, and 2048 MB

Standard Memory

- 256 MB (256 MB x 1)
- 512 MB (512 MB x 1 or 256 MB x 2)
 1024 MB (1024 MB x 1 or 512 MB x 2)
- 2048 MB (1024 MB x 2)

Optional Memory Upgrades

Support for up to 4096 MB* of memory is available (with the installation of optional DDR2 SDRAM memory kits). Both memory slots are user accessible. Please refer to the Hardware and Software Guide for installation procedures. Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

Up to	Slot 1	Slot 2
768 MB	512 MB	256 MB
1024 MB	1024 MB	Empty
1024 MB	512 MB	512 MB
1280 MB	1024 MB	256 MB
1536 MB	1024 MB	512 MB
2048 MB	1024 MB	1024 MB
4096 MB*	2048 MB	2048 MB

NOTE: This chart does not represent all possible memory configurations. Due to the non-industry standard nature of some third-party memory modules, we strongly recommend using only HP branded memory modules to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

Memory Upgrades

HP 512-MB (DDR2 667 MHz) SODIMM HP 1-GB (DDR2 667 MHz) SODIMM HP 2-GB (DDR2 667 MHz) SODIMM EM993AA

EM994AA EM995AA

^{*} Above 3-GB, all memory may not be available due to system resource requirements.



Storage

Removable Media Drive Support

	Quantity Supported	Drive Bay
LightScribe DVD+/-RW SuperMulti Drive with Double Layer Drive	One	Fixed optical drive bay
DVD+/-RW SuperMulti Drive with Double Layer	One	Fixed optical drive bay
DVD/CD-RW Combo Drive	One	Fixed optical drive bay
CD-ROM Drive	One	Fixed optical drive bay

Hard Drive Support

	Quantity Supported	Drive Bay
Primary Hard Drives		
100-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
80-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
60-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
40-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay



Technical Specifications

System Unit Dimensions (HxWxD) 1.2 (at front) x 12.9 x 10.8 in (30.3 (at front) x 328.6 x 247.3 mm)

> Weight 5.7 lb (2.6 kg)

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes 6-cell battery, 60-GB hard drive, 256-MB memory, and CD-ROM drive. Weight varies by configuration and components.

Stand-Alone Power Normal Operating 18.5 V

Requirements Voltage

> Average Operating Power 12.5 W Max Operating Power < 65 W

Temperature Operating 32° to 95° F (0° to 35° C) (not writing optical)

41° to 95° F (5° to 35° C) (writing optical)

-4° to 140° F (-20° to 60° C) Non-operating

Relative Humidity Operating 10% to 90%, non-condensing

> 5% to 95%, 101.6° F (38.7° C) maximum wet Non-operating

bulb temperature

Shock 125 G, 2 ms, half-sine Operating

> Non-operating 200 G, 2 ms, half-sine

Random Vibration Operating 0.75 grms

1.50 grms Non-operating

Altitude -50 to 10,000 ft (-15.24 to 3,048 m) Operating (unpressurized) -50 to 40,000 ft (-15.24 to 12,192 m) Non-operating

Industry Standard UL Yes Certifications **CSA** Yes

> **FCC** Compliance Yes **Energy Star Compliant** Yes **ICES** Yes GS Yes Yes

Australia / NZ A-Tick

Compliance

CCC Yes Japan VCCI Compliance Yes

MIC Yes **BSMI** Yes CE Marking Compliance Yes **BNCI or BELUS** Yes CIT Yes

GOST Yes Saudi Arabian Yes

Compliance (ICCP)

SABS Yes **UKRSERTCOMPUTER** Yes



Technical Specifications

HP 65W	Smart AC
Adapter	

Dimensions 4.17 x 1.85 x 1.1 in (10.6 x 4.7 x 2.8 cm)

Weight 0.62 lb (280 g) 100 to 240 VAC Input

> Input Efficiency 83% min at 115 VAC

47 to 63 Hz Input frequency range

Input AC current 1.7 A at 90 VAC, 0.85 A at 180 VAC

Output Output power 65W 65W

> DC output 18.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector 3 pin/grounded, mates with interchangeable cords Environmental Design

32° to 104° F (0° to 40° C) Operating temperature

Non-operating (storage)

-4° to 149° F (-20° to 65° C)

temperature

Altitude 0 to 10,000 ft (0 to 3,048 m)

Humidity 20% to 80% 10% to 90% Storage Humidity

EMI and Safety Certifications

CE Mark – full compliance with LVD and EMC directives; Worldwide safety

standards - IEC60950, EN60950, UL60950, Class 1, SELV; Agency

approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF – over 200,000 hours at

25°C ambient condition.

Option Kit Contents 65W AC Adapter, power cable, warranty booklet

Optional HP 12-Cell **Ultra-Capacity Battery** Dimensions $(H \times W \times L)$

1.3 x 6.0 x 10.6 in (3.33 x 15.25 x 26.88 cm)

Weight 1.77 lb (0.803 kg) Cells/Type 12-cell Lithium-Ion

Energy Voltage 14.8V

Watt-hour Capacity 95Wh **Amp-hour Capacity** 6.45Ah

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

> Operating (Discharging) 14° to 140° F (-10° to 60° C) -4° to 140° F (-20° to 60° C) Non-operating

3 to 4 hours Battery Re-Charge Time Smart Adapter

> 4 to 5 hours (depending on system power System ON

> > consumption)

Fuel Gauge When pressed, LEDs light indicating level of charge remaining on battery



Technical Specifications

Optional	HP 8-Cell
Extended	Life Battery

Dimensions (H x W x L) 1.0 x 3.9 x 8.7 in (2.5 x 10.0 x 22.0 cm)

Weight 1.00 lb (0.455 kg)
Cells/Type 8-cell Lithium-Ion

Energy Voltage 14.4V Watt-hour Capacity 52Wh

Amp-hour Capacity 3.6Ah

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C) Non-operating -4° to 140° F (-20° to 60° C)

Battery Re-Charge Time System in OFF mode or 3 hours

Standby

System ON 3 to 5 hours (depending on system power

consumption)

HP Fast Charge Charges the battery up to 90% within 90 minutes

Technology when system is OFF

Fuel Gauge When pressed, LEDs light indicating level of charge remaining on battery

55Wh Primary 6-Cell Battery

Dimensions $(H \times W \times L)$

0.8 x 2.1 x 8.0 in (2.0 x 5.3 x 20.3 cm)

Weight 0.737 lb (0.335 kg)
Cells/Type 6-cell Lithium-lon

Energy Voltage 10.8V Watt-hour Capacity 55Wh

Amp-hour Capacity 5.1Ah

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 140° F (-10° to 60° C)

Non-operating -4° to 140° F (-20° to 60° C)

Battery Re-Charge Time System in OFF Mode or 2.5 hours

Standby

System ON 3 to 5 hours (depending on system power

consumption)

HP Fast Charge Charges the battery up to 90% within 90 minutes

Technology when system is OFF

Technical Specifications

43Wh Primary 6-Cell

Dimensions $(H \times W \times L)$

 $0.8 \times 2.1 \times 8.0$ in $(2.0 \times 5.3 \times 20.3 \text{ cm})$

Battery

Weight 0.715 lb (0.325 kg) Cells/Type 6-cell Lithium-Ion

Energy Voltage 10.8V Watt-hour capacity 43Wh

> Amp-hour capacity 4.0Ah

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

> Operating (Discharging) 14° to 140° F (-10° to 60° C) -4° to 140° F (-20° to 60° C)

Non-operating

Battery Re-Charge Time

System in OFF mode or

2.5 hours

Standby

System ON 3 to 5 hours (depending on system power

consumption)

HP Fast Charge Technology

Charges the battery up to 90% within 1.5 hours

when system is OFF

15.0-Inch Color TFT SXGA+ Wide Viewing Angle Display

Active Area (W x H)

12.0 x 9.0 in (30.4 x 22.8 cm)

Diagonal Size

15.0 in (38.0 cm)

Surface Treatment Number of Colors Contrast Ratio

Anti-glare Up to 16M 300:1 (typical)

Refresh Rate

60 Hz

Brightness

170 nit (typical)

Pixel Resolution Pitch 0.217 mm 1400 x 1050

Format Configuration

RGB Stripe

CCFL Backlight 117

PPI

 $\pm 60^{\circ}$ Horizontal, $+40^{\circ}/-45^{\circ}$ Vertical (typical) Viewing Angle

Technical Specifications

15.0-Inch Color TFT XGA BrightView Display Active Area (W x H) 12.0 x 9.0 in (30.4 x 22.8 cm)

Diagonal Size 15.0 in (38.0 cm)

Surface TreatmentBrightViewNumber of ColorsUp to 16MContrast Ratio300:1 (typical)

Refresh Rate 60 Hz

Brightness 150 nit (typical)

 Pixel Resolution
 Pitch
 0.296 mm

 Format
 1024 x 768

Configuration RGB Stripe

Backlight CCFL **PPI** 86

Viewing Angle $\pm 45^{\circ}$ Horizontal, $\pm 25^{\circ}$ Vertical (typical)

15.0-Inch Color TFT XGA Display Active Area (W x H) 12.0 x 9.0 in (30.4 x 22.8 cm)

Diagonal Size 15.0 in (38.0 cm)

Surface TreatmentAnti-glareNumber of ColorsUp to 16MContrast Ratio300:1 (typical)

Refresh Rate 60 Hz

Brightness 150 nit (typical)

Pixel Resolution Pitch 0.296 mm

Format 1024 x 768
Configuration RGB Stripe

Backlight CCFL PPI 86

Viewing Angle $\pm 45^{\circ}$ Horizontal, $\pm 25^{\circ}$ Vertical (typical)

Hard Drives

Technical Specifications

100-GB 5400 rpm SATA Drive Weight 0.22 lb (101 g)

Capacity 100 GB

 Height
 0.37 in (9.5 mm)

 Width
 2.75 in (70 mm)

 Interface
 ATA-7 / SATA 1.0a

Transfer Rate Synchronous (maximum) 100 MB/s (Drive Capability)

Seek TimeSingle Track3 ms(typical reads, including settling)Average13 msMaximum24 ms

Rotational Speed 5400 rpm Logical Blocks 195,371,568

Operating Temperature 41° to 140° F (5° to 60° C) [case temp]

Features ATA Security

80-GB 5400 rpm SATA Drive Weight 0.22 lb (101 g)

Capacity 80 GB

 Height
 0.37 in (9.5 mm)

 Width
 2.75 in (70 mm)

 Interface
 ATA-7 / SATA 1.0a

Transfer Rate Synchronous (maximum) 100 MB/s (Drive Capability)

Seek TimeSingle Track3 ms(typical reads, including settling)Average13 msMaximum24 ms

Rotational Speed 5400 rpm Logical Blocks 156,301,488

Operating Temperature 41° to 140° F (5° to 60° C) [case temp]

Features ATA Security

60-GB 5400 rpm SATA Drive Weight 0.22 lb (101 g)

Capacity 60 GB

 Height
 0.37 in (9.5 mm)

 Width
 2.75 in (70 mm)

 Interface
 ATA-7 / SATA 1.0a

Transfer Rate Synchronous (maximum) 100 MB/s (Drive Capability)

Seek TimeSingle Track3 ms(typical reads, including settling)Average13 msMaximum24 ms

Rotational Speed 5400 rpm Logical Blocks 117,231,408

Operating Temperature 41° to 140° F (5° to 60° C) [case temp]

Features ATA Security

Technical Specifications

40-GB 5400 rpm SATA

Drive Weight 0.22 lb (101 g)

Capacity 40 GB

Height 0.37 in (9.5 mm) Width 2.75 in (70 mm) Interface ATA-7 / SATA 1.0a

Transfer Rate Synchronous (maximum) 100 MB/s (Drive Capability)

Seek Time Single Track (typical reads, including Average 13 ms settling) 24 ms

Maximum

Rotational Speed 5400 rpm Logical Blocks 78,165,360

Operating Temperature 41° to 140° F (5° to 60° C) [case temp]

Features ATA Security

Removable Storage Drives - Fixed Bay

CD-ROM Drive Access Times Random

> Max Data Transfer Rate 24X CD-ROM 3,600 KB/s

Transfer Mode Multiword DMA Mode 2

EIDE Interface

Supported Media (read) CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED

MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD

(Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW

<110 ms CD

Supported Media (write) None Max Media Capacity 700 MB

(read)

Transport

Tray Loading

DVD/CD-RW Combo

Drive

Access Times Random <110 ms CD

<130 ms DVD

Max Data Transfer Rate 24X CD-ROM 3,600 KB/s

> 8X DVD 10,800 KB/s 24X CD-R 3,600 KB/s 24X CD-RW 3,600 KB/s

Transfer Mode Multiword DMA Mode 2

Interface **EIDE**

CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED Supported Media (read)

> MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R,

DVD+RW

CD-R, CD-RW Supported Media (write)

Max Media Capacity 8.5 GB

(read)



Technical Specifications

Max Media Capacity

(write)

700 MB

Transport

Tray loading

LightScribe DVD+/-RW SuperMulti Drive with Double Layer Access Times

Random

<175 ms CD

<230 ms DVD

Max Data Transfer Rate

24X CD-ROM

3,600 KB/s 10,800 KB/s

24X CD-R

8X DVD

3,600 KB/s

16X CD-RW

2,400 KB/s

8X DVD+R4X DVD+RW 10,800 KB/s 5,400 KB/s

8X DVD-R

10,800 KB/s

4X DVD-RW

5,400 KB/s 2,700 KB/s

2.4X DVD+R(9) 5X DVD-RAM

6,750 KB/s

Transfer Mode

Multiword DMA Mode

Interface

EIDE

Supported Media (read)

CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I CD-I Bridge (Photo-CD, Video CD), Multisession CD

MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R,

DVD+RW. DVD-RAM, LightScribe

Supported Media (write)

 $\mathsf{CD}\text{-R},\,\mathsf{CD}\text{-RW},\,\mathsf{DVD}+\mathsf{R},\,\mathsf{DVD}+\mathsf{RW},\,\mathsf{DVD}\text{-R},\,\mathsf{DVD}\text{-RW},\,\mathsf{DVD}\text{-RAM}$

Max Media Capacity

(read)

8.5 GB

Max Media Capacity

8.5 GB

(write)

Transport Tray Loading



Technical Specifications

DVD+/-RW SuperMulti
Drive with Double Layer

Access Times Random <175 ms CD

8X DVD

<230 ms DVD

Max Data Transfer Rate 24X CD-ROM

3,600 KB/s 10,800 KB/s 3,600 KB/s

24X CD-R 16X CD-RW 8X DVD+R 4X DVD+RW

2,400 KB/s 10,800 KB/s 5,400 KB/s

 4X DVD RW
 5,400 KB/s

 8X DVD-R
 10,800 KB/s

 4X DVD-RW
 5,400 KB/s

2.4X DVD+R(9) 2,700 KB/s 5X DVD-RAM 6,750 KB/s

Transfer Mode Multiword DMA Mode

Interface EIDE

Supported Media (read) CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED

MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R,

DVD+RW. DVD-RAM

Supported Media (write)

CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW, DVD-RAM

Max Media Capacity

(read)

8.5 GB 8.5 GB

Max Media Capacity

(write)

· . .

Transport Tray Loading

HP Biometric Fingerprint

Sensor

Mobile Voltage

Operation

3.0V–3.6V Single Supply

Operating Temperature

32° - 158°F (0° - 70°C)

Current Consumption @

3.3V

Less than 70 mA peak imaging and scrolling Less than 25 mA hardware finger detection

Less than 25 mA hardware finger detection Advanced Power Management

High-Rate Image Capture Up to 240 image frames /sec

ESD Resistance

IEC 61000-4-2 Level 4 (±15KV)

Detection Matrix 192 x 16 Pixels

9.7mm x 0.81mm

500 ppi High-Resolution Images

Audio



Technical Specifications

Hardware **Implementation** ADI1981HD High Definition CODEC

> Volume Controls Up, down, and mute buttons

> > Yes

Yes

Full Duplex Sound Blaster Pro

compatible

Microphone Jack Stereo or mono

Headphone/Line Out

Jack

Stereo

Audio Output Quality Frequency Response 20 Hz - 20 kHz

> Signal to Noise Ratio $> 85 \, dB$ Total Harmonic Distortion 0.01% Noise Floor -110 dB

Play/Record Sampling

Rate(s)

8 kHz - 48 kHz

DAC 16, 20 or 24-bit **ADC** 16 or 20-bit

Internal Speakers **Power Rating** 2 Watts

4 Ohms Impedance

Communications

Integrated Broadcom **Ethernet Features** 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) NetLink Gigabit Ethernet 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-

PCI Controller (BCM5788M)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3z and 802.3ab; IEEE

802.3 clauses 34-42)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

30)

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

Power Management ACPI compliant -- multiple power modes

Situation-sensitive features reduce power consumption

NIC Battery Saving Mode (enabled by default)

Performance Features

TCP/IP/UDP Checksum Offload (configurable)

Manageability

Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Interface 32-bit PCI, 33-MHz

NIC Device Driver Name Broadcom NetLink Gigabit Ethernet



Technical Specifications

Drivers Available Microsoft Windows XP

Microsoft Windows 2000

V.92 56K Data/Fax Modem Form Factor

MDC 1.5 Daughtercard

Power Management

APM Revision 1.2, ACPI

Support

Approvals/ Certifications UL, CSA, NEMKO, CCIB, Industry Canada, FCC Part 68, CTR21, FCC Part 15 Class B, Canadian ICES-003 Class B, C.I.S.P.R.22, Australian ACA, CE

Mark, Other Countries

Data Mode Capabilities

V.92 data V.8bis

V.80 V44, V.42bis, MNP5 (Compression) V.42 (LAPM, MNP2-4) (Error Correction)

Optional symbol rates:

2800, 3429

Asymmetric Symbol rates

Synchronous primary channel data signaling rates:

3600, 31200

Automatic rate re-negotiation

V.34 V.32bis V.32 V.23 V.22bis V.22 V.21

Bell 212A Bell 103J

Fax Mode Capabilities

TIA/EIA-578-B (Class 1)

T.30, T.4 (Group 3)

V.17 V.29 V.27ter

V.21 Channel 2

Command Set

V.250 (Partial)

TIA-602

Identification: +GMI, +GMM, +GMR Port control: +IPR, +ICF, +IFC, +ILRR

Modulation: +MS, +MR, +MA

Error control: +ES, +ER, +EB, +ESR, +ETBM

Data compression: +DS, +DR

V.251

Broadcom 4311BG 802.11b/g WiFi Adapter Wireless LAN Standards IEEE

IEEE 802.11b IEEE 802.11g

Interoperability

Wi-Fi certified

Cisco Compatible Extensions Program compliant (details at www.hp.com/go/notebooks/WLAN)



Technical Specifications

Frequency Band 2.4 GHz

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM

Security¹ Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES,

802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-

MSCHAPv2, LEAP, EAP-FAST, EAP-SIM.

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program

Version 4).

Sub-channels Multinational support with frequency bands and channels compliant to local

regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points Roaming

Output Power (for CKK)² 17.5 dBm Output Power (for OFDM; 15 dBm

power varies by data

rate)2

Power Consumption Transmit: 2.0 W (max)

Receive: 1.5 W (max)

Idle mode³: 390 mW (nominal) Sleep mode: 20 mW (max)

ACPI compliant power management Power Management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 54 Mbps: -72 dBm, 11 Mbps: -88 dBm, 1 Mbps: -97 dBm

High efficiency dual band antenna with spatial diversity, mounted in the Antenna type

display enclosure

Range 802.11 b - Typical 1200 feet – Outdoor Open Area

> 300 feet - Indoor, Office environment (@1 Mbps) 802.11 g - Typical 1200 feet – Outdoor Open Area 300 feet - Indoor, Office environment

(@1 Mbps)

Form Factor PCI-Express MiniCard

Weight 0.026 lb (12 g)

Dimensions 0.19 x 1.2 x 2.0 in (4.75 x 29.85 x 50.8 mm)

3.3v +/- 10% Operating Voltage

32° to 176° F (0° to 80° C) **Temperature** Operating

> Non-operating -40° to 176° F (-40° to 80° C)

10% to 90% (non-condensing) Humidity Operating

5% to 95% (non-condensing) Non-operating

Altitude 0 to 10,000 ft (3,048 m) Operating

Non-operating 0 to 50,000 ft (15,240 m)





Technical Specifications

Configuration Utility⁵ Choice of Configuration Utility:

- Microsoft Windows XP Wireless Network Connection Manager
- Broadcom Wireless Configuration Utility (required for Cisco Compatible Extensions support)

LED Activity LED Off – Radio OFF; Solid LED On – Radio ON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. In Power Save Polling mode.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- WLAN supplier's client utility is required for Cisco Compatible Extensions support. WLAN may also be compatible with certain third-party software supplicants.

Broadcom 4311AG 802.11a/b/g WiFi Adapter Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

Interoperability Wi-Fi certified

Cisco Compatible Extensions Program compliant (details at www.hp.com/go/notebooks/WLAN)

Frequency Band 2.4 GHz and 5 GHz

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM

Security¹ Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES,

802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-

MSCHAPv2, LEAP, EAP-FAST, EAP-SIM.

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program

Version 4).

Sub-channels Multinational support with frequency bands and channels compliant to local

regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power (for CKK)² 17.5 dBm Output Power (for OFDM; 15 dBm

power varies by data

rate)2

Power Consumption Transmit: 2.0 W (max)

Receive: 1.5 W (max)

Idle mode³: 390 mW (nominal) Sleep mode: 20 mW (max)

Power Management ACPI compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 54 Mbps: -72 dBm, 11 Mbps: -88 dBm, 1 Mbps: -97 dBm



Technical Specifications

Antenna type High efficiency dual band antenna with spatial diversity, mounted in the

display enclosure

Range 802.11 a – Typical 600 feet – Outdoor Open Area

(@6 Mbps)

150 feet – Indoor, Office environment

802.11 b – Typical

1200 feet – Outdoor Open Area

300 feet – Indoor, Office environment

802.11 g – Typical 1200 feet – Outdoor Open Area (@1 Mbps) 300 feet – Indoor, Office environment

Form Factor PCI-Express MiniCard

Weight 0.026 lb (12 g)

Dimensions 0.19 x 1.2 x 2.0 in (4.75 x 29.85 x 50.8 mm)

Operating Voltage 3.3v +/- 10%

Temperature Operating 32° to 176° F (0° to 80° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)
Operating 0 to 10,000 ft (3,048 m)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

Configuration Utility⁵ Choice of Configuration Utility:

• Microsoft Windows XP Wireless Network Connection Manager

 Broadcom Wireless Configuration Utility (required for Cisco Compatible Extensions support)

LED Off – Radio OFF; Solid LED On – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. In Power Save Polling mode.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support. WLAN may also be compatible with certain third-party software supplicants.

HP Integrated Module with Bluetooth Wireless Technology

Bluetooth Specification 2.0 Compliant

Dimensions 1.02 x 0.55 x 0.22 in (26 x 14 x 5.7 mm)

Frequency Band 2402 to 2480 MHz

Number of Available 79 (1 MHz) available channels

Channels

Data Rates and 3 Mbps data rate; throughput up to 2.17 Mbps

Throughput Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or

1306.9 kbps symmetric

Transmit Power -6 dBm to 4 dBm (Bluetooth Class II)

Receiver Sensitivity Better than -80 dBM at 0.1 % raw bit error rate

Power Consumption Peak (Tx) 264 mW

Peak (Rx) 231 mW Sleep <1 mW

Antenna Internally integrated within module



Technical Specifications

Range Up 33 ft (10 m) Electrical Interface USB 2.0 compliant

Microsoft Windows Plug and Play compliant

Microsoft Windows XP Professional and Home **OS Support**

Microsoft Windows 2000

Bluetooth Software

Broadcom Bluetooth for Windows

Supported Microsoft Windows XP Bluetooth Software

Link Topology Point to Point, Multipoint Pico Nets up to 7 slaves Security Full support of Bluetooth Security Provisions

Power Management Microsoft Windows ACPI, and USB Bus Support

including Standby, Hold, Park, and Sniff

Certifications All necessary regulatory approvals for supported countries, including:

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Self configurable to optimize power conservation in all operating modes,

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Temperature Operating -4° to 158° F (-20° to 70° C)

> Non-operating -40° to 176° F (-40° to 80° C)

10% to 90% Humidity Operating

> Non-operating 5% to 95%

Altitude 15,000 ft (4,572 m) Operating

> Non-operating 40,000 ft (12,192 m)

Bluetooth Profiles

Supported

Serial Port Profile (SPP)*

Dial-Up Networking (DUN)*

Generic Object Exchange Profile (GOEP)

(with Bluetooth for Windows 4.0 software)

Object Push Profile (OPP)* File Transfer Profile (FTP) Synchronization Profile (SYNC)

Hard Copy Cable Replacement (HCRP)* Personal Area Networking Profile (PAN)* Human Interface Device Profile (HID)*

FAX Profile (FAX)

Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)



 $[^]st$ indicates the profile is also supported by Microsoft Windows XP SP2

Technical Specifications

Environmental Data

Eco-Label Certifications

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US Energy Star
- US Federal Energy Management Program (FEMP)
- Taiwan Green Mark
- China Energy Conservation Program
- IT ECO declaration
- Korean Eco Label

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a "Typically Configured Notebook."

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	25.8 W	25.0 W	25.5 W
Sleep (Energy Star low power mode)	1.12 W	1.40 W	1.13 W
Off	1.30 W	1.47 W	1.25 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	88 BTU/hr	85 BTU/hr	87 BTU/hr
Sleep	3.8 BTU/hr	4.8 BTU/hr	3.9 BTU/hr
Off	4.4 BTU/hr	5.0 BTU/hr	4.3 BTU/hr

^{*}NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
3.0	23
3.9	24
	3.0

Batteries

This product complies with ISO standards:

EU Directive 91/157/EEC EU Directive 93/86/EEC EU Directive 98/101/EEC

Batteries used in the product do not contain:

Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 4000 ppm by weight.

Battery type and chemistry used in the product:

Primary battery 6-cell high capacity Lithium-Ion battery pack

Real Time Clock battery CR2032 (coin cell), Lithium



Technical Specifications

Additional Information

This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2002/95/EC.

This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.

Keyboard complies with ISO standard: ISO 9995, EN 29241-4, and ISO/IEC 15412

Input devices of this product comply with ISO 9241, part 9.

Plastics parts weighing over 0.055 pounds (25 grams) used in the product are marked per ISO 11469 and ISO1043.

This product contains 0% recycled materials (by wt.)

This product is greater than 85% recycle-able when properly disposed of at end of life.

Packaging

Packaging Materials

- External:
 - O Corrugated Paper 2.03 lb (920 g)
- Internal:
 - EPE Foam 0.19 lb (85 g)
 - LDPE Bag 0.01 lb (5 g)
 - O Corrugated Paper 1.84 lb (835 g)
- The corrugated paper packaging materials contains at least 40% recycled content.

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.



Technical Specifications

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment

(http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

End-of-life Management and Recycling

HP offers our customers several other options for handling their aging computers while also minimizing the impact on the environment-including product trade-in and leasing services-in addition to recycling services. Please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Environment website

http://www.hp.com/environment

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html



Technical Specifications

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